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Vishay Siliconix



FEATURES

P-Channel 20 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Load switch
- · Battery switch
- Power management



COMPLIANT



ORDERING INFORMAT	ΓΙΟΝ	
Configuration	Single	
I _D (A) ^d	-12.5	
Q _g typ. (nC)	63	
$R_{DS(on)}$ max. (Ω) at V_{GS} = -1.8 V	0.0227	

-20

0.0098

0.0130

ONDERING INI ONMATION	
Package	TSSOP-8
Lead (Pb)-free and halogen-free	Si6423ADQ-T1-GE3

ABSOLUTE MAXIMUM RATINGS (TA :	= 25 °C, unless otherwi	ise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	-20	V
Gate-source voltage		V _{GS}	± 8	V
	T _C = 25 °C		-12.5	
Continuous drain surrent (T 150 °C) à	T _C = 70 °C		-10	
Continuous drain current (T _J = 150 °C) ^a	T _A = 25 °C	- I _D	-10.3 ^{a, b}	
	T _A = 70 °C		-8.2 ^{a, b}	
Pulsed drain current (t = 300 μs)		I _{DM}	-70	A
Operation of the second state of the second st	T _C = 25 °C	- I _S	-1.9	
Continuous source-drain diode current	T _A = 25 °C		-1.3	
Avalanche current	L = 0.1 mH	I _{AS}	-20	
Single pulse avalanche energy	·	E _{AS}	20	mJ
Maximum power dissipation	T _C = 25 °C	- P _D	2.2	W
	T _C = 70 °C		1.4	
	T _A = 25 °C		1.5 ^{a, b}	
	T _A = 70 °C		1.0 ^{a, b}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^{a, c}	t ≤ 10 s	R _{thJA}	65	83	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	46	56	0/00

Notes

a. Surface mounted on 1" x 1" FR4 board

b. t = 10 s

V_{DS} (V)

 $R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V

 $R_{DS(on)}$ max. (Ω) at V_{GS} = -2.5 V

c. Maximum under steady state conditions is 120 °C/W d. $T_C = 25\ ^\circ\text{C}$

u. 10 = 25 0

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Si6423ADQ

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	-20	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$	1 2504	-	-11	-	m)//0C
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μΑ	-	2.9	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.4	-	-1	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 8 \text{ V}$	-	-	± 100	nA
Zaus and a subtract due in assumed		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	
Zero gate voltage drain current	IDSS	V _{DS} = -20 V, V _{GS} = 0 V, T _J = 55 °C	-	-	-10	μA
On-state drain current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	-10	-	-	Α
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	-	0.0082	0.0098	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -2.5 V, I _D = -8 A	-	0.0108	0.0130	Ω
		V _{GS} = -1.8 V, I _D = -5 A	-	0.0175	0.0227	
Forward transconductance ^a	g _{fs}	V _{DS} = -10 V, I _D = -10 A	-	70	-	S
Dynamic ^b		·				
Input capacitance	C _{iss}		-	5875	-	
Output capacitance	Coss	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	-	540	-	pF
Reverse transfer capacitance	C _{rss}		-	555	-	
Total and a share a	0	$V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_D = -16.7 \text{ A}$	-	112	168	
Total gate charge	Qg		-	63	95	
Gate-source charge	Q _{qs}	V _{DS} = -10 V, V _{GS} = -4.5 V, I _D = -16.7 A	-	8.7	-	nC
Gate-drain charge	Q _{gd}		-	25.3	-	-
Gate resistance	Rg	f = 1 MHz	0.8	3.6	7.2	Ω
Turn-on delay time	t _{d(on)}		-	12	24	
Rise time	tr	$V_{DD} = -10 \text{ V}, \text{ R}_{1} = 1 \Omega,$	-	4	8	
Turn-off delay time	t _{d(off)}	$I_D \cong -10$ Å, $V_{GEN} = -8$ V, $R_g = 1 \Omega$	-	120	180	ns
Fall time	t _f		-	36	54	
Drain-Source Body Diode Characteris	tics	· · · ·			•	
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-18	^
Pulse diode forward current ^a	I _{SM}		-	-	-70	A
Body diode voltage	V _{SD}	I _S = -10 A	-	-0.75	-1.2	V
Body diode reverse recovery time	t _{rr}		-	45	68	ns
Body diode reverse recovery charge	Q _{rr}		-	38	57	nC
Reverse recovery fall time	ta	I_F = -10 A, di/dt = 100 A/µs, T _J = 25 °C -	-	18	-	
Reverse recovery rise time	t _b	1	-	27	-	ns

Notes

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

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Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

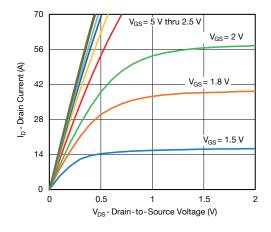
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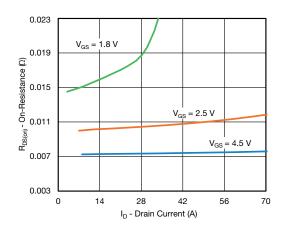


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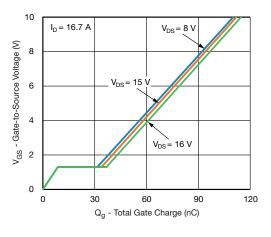
TYPICAL CHARACTERISTICS (T_J = 25 °C, unless otherwise noted)



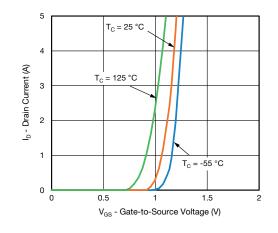
Output Characteristics



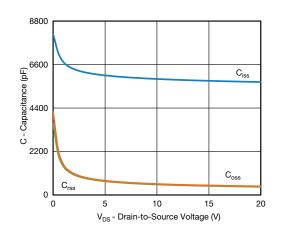
On-Resistance vs. Drain Current



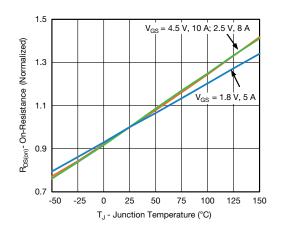
Gate Charge



Transfer Characteristics



Capacitance



Normalized On-Resistance vs. Junction Temperature

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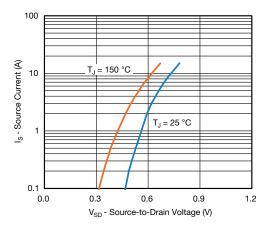
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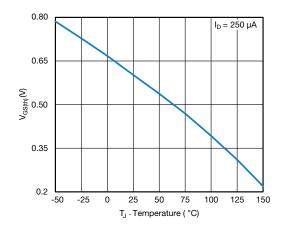


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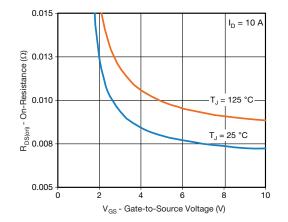
TYPICAL CHARACTERISTICS ($T_J = 25 \text{ °C}$, unless otherwise noted)



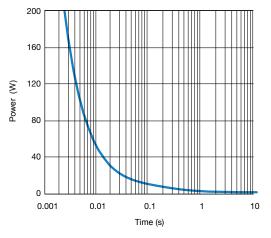
Source-Drain Diode Forward Voltage



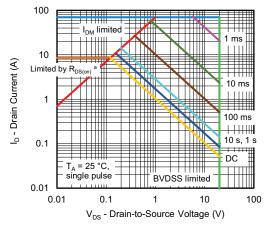




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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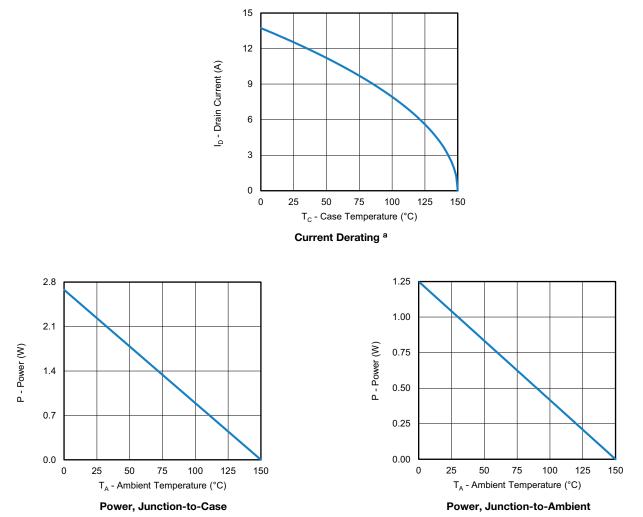
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TYPICAL CHARACTERISTICS ($T_J = 25 \text{ °C}$, unless otherwise noted)



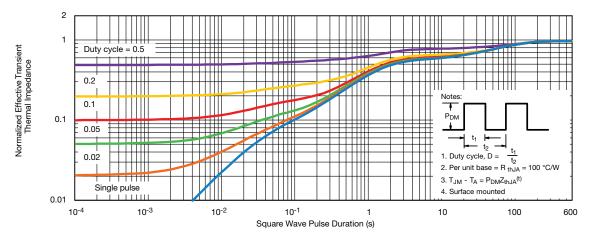
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

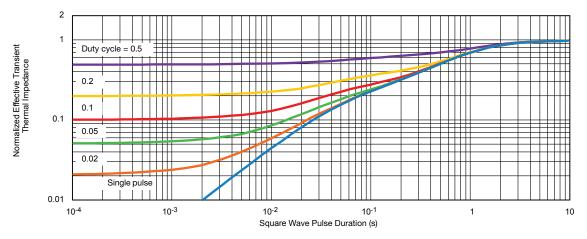


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TYPICAL CHARACTERISTICS (T_J = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

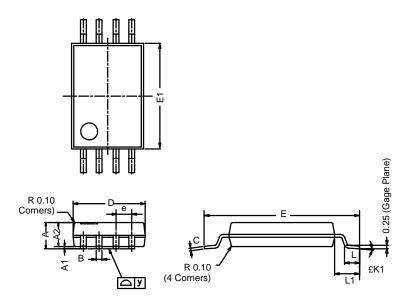
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Package Information Vishay Siliconix

TSSOP: 8-LEAD JEDEC Part Number: MO-153



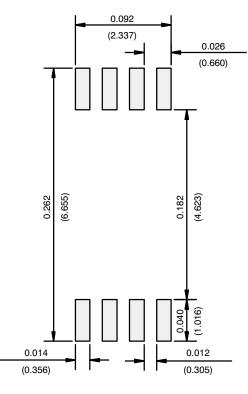
	MILLIMETERS			
Dim	Min	Nom	Max	
Α	-	-	1.20	
A ₁	0.05	0.10	0.15	
A ₂	0.80	1.00	1.05	
В	0.19	0.28	0.30	
С	-	0.127	-	
D	2.90	3.00	3.10	
Е	6.20	6.40	6.60	
E ₁	4.30	4.40	4.50	
е	-	0.65	-	
L	0.45	0.60	0.75	
L ₁	0.90	1.00	1.10	
Y	-	-	0.10	
£ K1	0°	3°	6°	
Ү £К1	- 0° 946—Rev. G, 0	- 3°	0.1	



Application Note 826

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RECOMMENDED MINIMUM PADS FOR TSSOP-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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